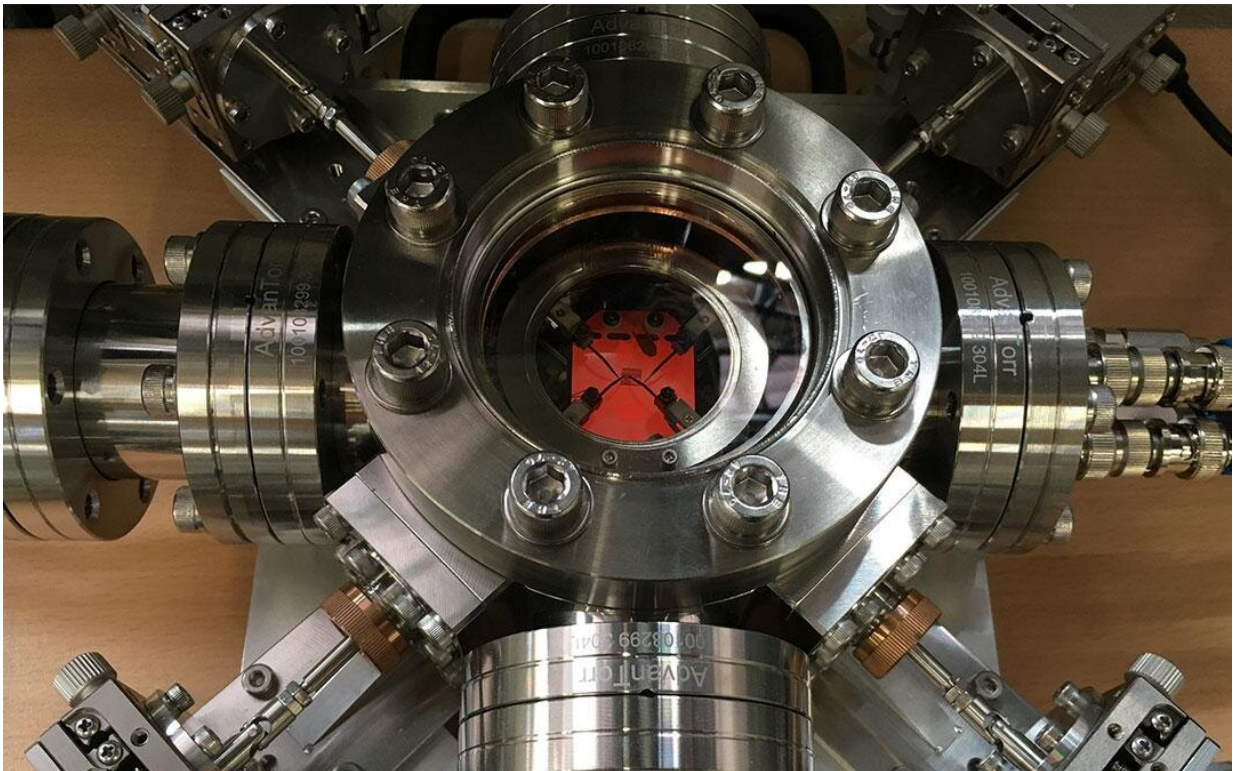


# Semiconductor devices for high-temperature environments exceeding 800°C

July 20 2023

---



The operational temperature range of Silicon (Si) devices is typically limited to temperatures below ~300°C. However, researchers from the University of Tsukuba succeeded in achieving stable operation of diodes at 827°C and transistors at 727°C using aluminum nitride (AlN) semiconductors. Credit: University of Tsukuba

Silicon (Si) semiconductors are ubiquitous in electrical appliances and

play an essential role in our daily lives. However, in high-temperature environments exceeding  $300^{\circ}\text{C}$ , such as underground resource drilling, space exploration, and engine peripherals, improved semiconductor materials are required because of the limited operational temperature range of Si devices.

Wide-bandgap semiconductors are preferable for high-temperature electronics. Currently, [aluminum nitride](#) (AlN) crystals are among the most attractive materials for high-temperature devices because they possess larger bandgap energy in comparison to other semiconductors.

Numerous studies have reported AlN diodes and transistors that can operate at temperatures above room temperature. However, the maximum operating temperatures of these AlN devices are limited to  $500^{\circ}\text{C}$  or lower owing to [technical problems](#) associated with electrical characterization systems.

This study, published in *Applied Physics Express*, presents the fabrication and evaluation of high-quality AlN-layered diodes and transistors using a novel electrical characterization system capable of functioning at temperatures up to  $900^{\circ}\text{C}$ .

The researchers achieved a successful demonstration of diode operation at  $827^{\circ}\text{C}$ , surpassing all previous records, and the transistors operated at  $727^{\circ}\text{C}$ . Furthermore, nickel electrodes in AlN devices remained stable even at  $827^{\circ}\text{C}$ . Notably, these AlN devices are practically feasible because the AlN layers are grown on large, low-cost sapphire substrates. Moreover, the AlN devices exhibited a simple structure.

This research has paved the way for operable semiconductor devices to operate in severe environments ( $>800^{\circ}\text{C}$ ). These AlN devices are expected to be employed in high-temperature industries such as underground mining, steel production, [space exploration](#), and aviation.

**More information:** Hironori Okumura et al, Temperature dependence of electrical characteristics of Si-implanted AlN layers on sapphire substrates, *Applied Physics Express* (2023). [DOI: 10.35848/1882-0786/acdcde](https://doi.org/10.35848/1882-0786/acdcde)

Provided by University of Tsukuba

Citation: Semiconductor devices for high-temperature environments exceeding 800°C (2023, July 20) retrieved 10 May 2024 from <https://techxplore.com/news/2023-07-semiconductor-devices-high-temperature-environments-exceeding.html>

<p>This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.</p>
--